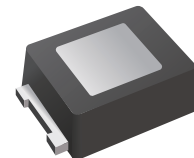




Features

- Top-side Cooling(TSC) Packaging technology
- Compact and Slim Packaging Solutions
- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- For surface mounted applications
- Metal silicon junction,majority carrier conduction
- Low power loss,high efficiency
- High forward surge current capability
- Lead free in comply with EU RoHS 2011/65/EU directives



Mechanical Data

- Case: SMHS
- Terminals: leads solderable per MIL-STD-750, Method 2026
- Polarity: Color band denotes cathode end
- Mounting Position: Any

Ordering Information

Part Number	Marking	Shipping	Reel
RH14HSL	S14L	15000PCS Tape&Reel	13 inches

Maximum Ratings and Electrical Characteristics

Ratings at 25°C ambient temperature unless otherwise specified.

Single phase half-wave 60Hz,resistive or inductive load,for capacitive load current derate by 20%.

Parameter	Symbol	RH14HSL	Unit
Maximum repetitive peak reverse voltage	V_{RRM}	40	V
Maximum RMS voltage	V_{RMS}	28	V
Maximum DC blocking voltage	V_{DC}	40	V
Maximum average forward rectified current at T_L (see fig.1)	$I_{(AV)}$	1	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I_{FSM}	45	A
Maximum instantaneous forward voltage at 1.0A	V_F	0.45	V
Maximum DC reverse current $T_A=25^{\circ}C$ at rated DC blocking voltage $T_A=100^{\circ}C$	I_R	0.1 10	mA
Typical thermal resistance (Note2)	$R_{\theta JA}$ $R_{\theta JC}$	62 7	$^{\circ}C/W$
Operating junction temperature range	T_J	-55 to +125	$^{\circ}C$
Storage temperature range	T_{STG}	-55 to +125	$^{\circ}C$

Note: (1) P.C.B. mounted with 0.08" × 0.08"(2mmx2mm) copper pad areas.



Characteristics Curves

FIG. 1 FORWARD CURRENT DERATING CURVE

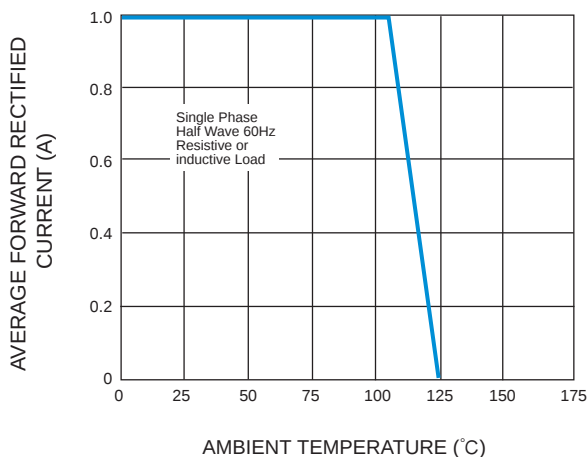


FIG. 2 MAXIMUM NON-REPETITIVE PEAK FORWARD SURGE CURRENT

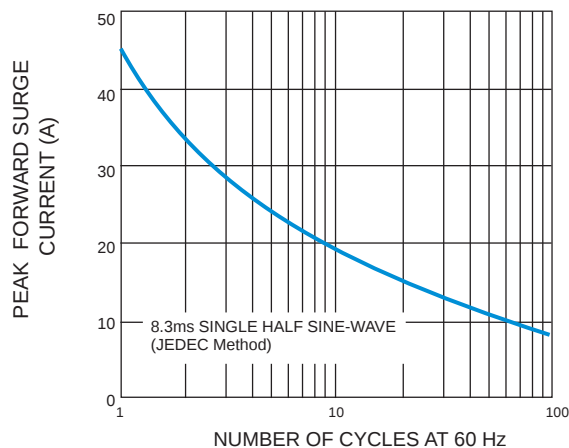


FIG. 3 TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS

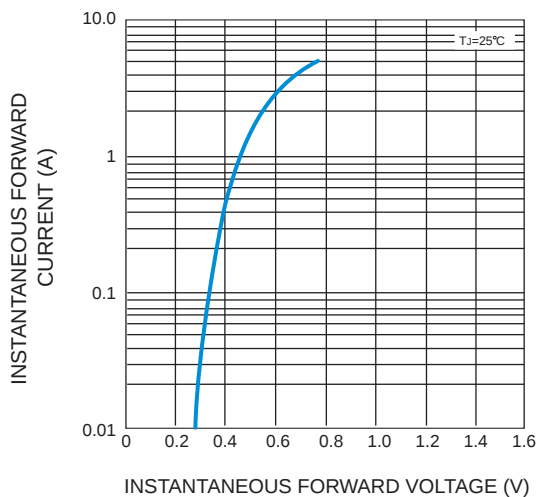


FIG. 4 TYPICAL REVERSE CHARACTERISTICS

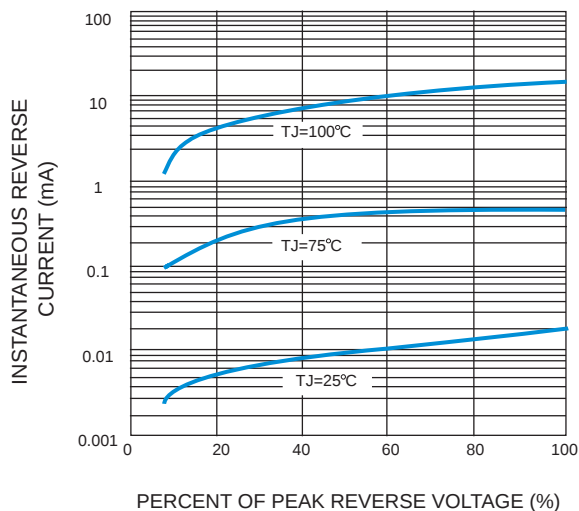
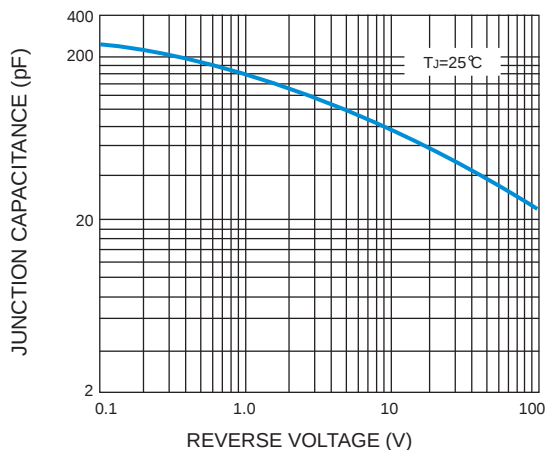


FIG. 5 TYPICAL JUNCTION CAPACITANCE





UNIT		A	C	D	E	H _E	d	e	f	h	∠
mm	max	0.99	0.25	2.90	2.10	3.50	1.30	1.30	1.25	0.70	6°
	min	0.83	0.15	2.50	1.70	2.90	1.10	1.10	1.05	0.50	

1. Controlling dimension:in millimeters.
2. General tolerance:±0.05mm
3. The pad layout is for reference purpose only.



Carrier Tape Dimensions

Unit : mm

Symbol	Spec	Symbol	Spec
W	8.00±0.10	P2	2.00±0.10
E	1.75±0.10	t	0.22±0.02
F	3.50±0.10	t1	Min. 0.05
D0	1.55±0.10	A0	2.15±0.10
D1	1.10±0.10	B0	3.40±0.10
P0	4.00±0.10	K0	1.15±0.10
P1	4.00±0.10		

Reel Dimensions

Unit : mm

13" Reel

D5	Φ330.0±5.0
D6	Φ13.5±0.5
H	2.5±1.0
W2	8.0±2.0
Quantity: 15000PCS	

Packaging

SMHS

15000 PCS/Reel

5 Reel/Inner Box
75K PCS/Inner Box

Dim(Unit:mm)
340mm*340mm*85mm

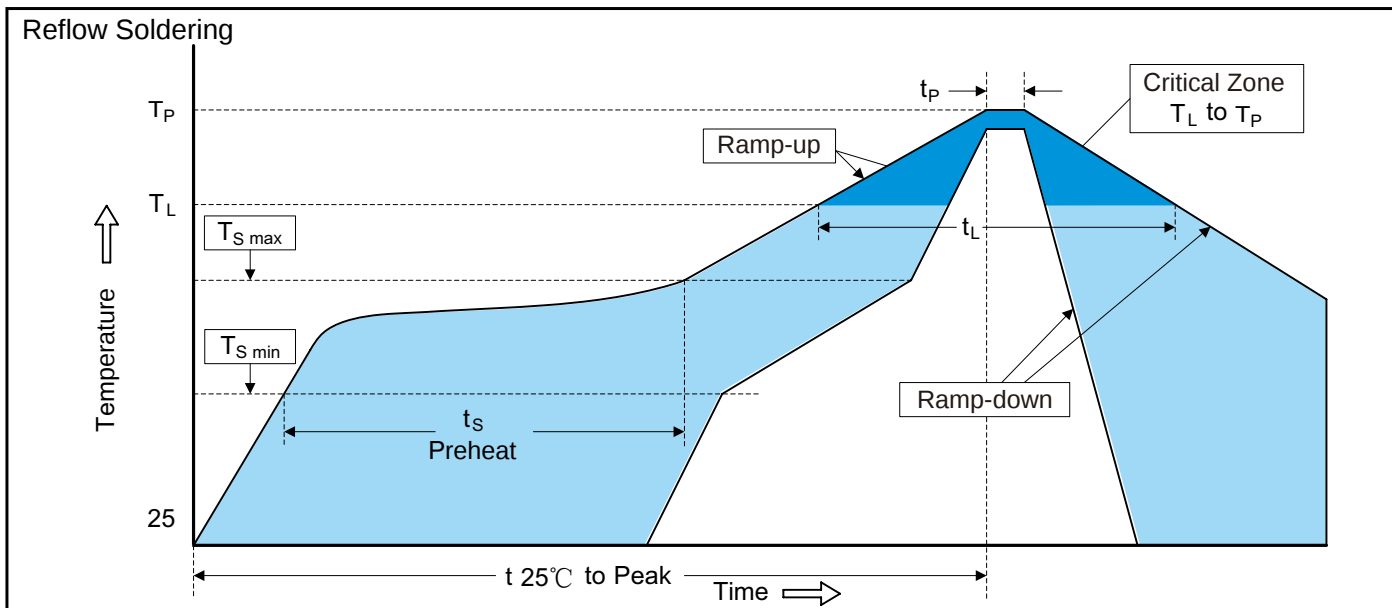
Dim(Unit:mm)
360mm*360mm*355mm

4 Boxes per carton
300K PCS per carton

13 inches Reel



Recommended Soldering Conditions



Recommended Conditions

Profile Feature	Pb-Free Assembly
Average ramp-up rate (T_L to T_P)	3°C/second max.
Preheat	
-Temperature Min ($T_{S\ min}$)	150°C
-Temperature Max ($T_{S\ max}$)	200°C
-Time (min to max) (t_s)	60-180 seconds
$T_{S\ max}$ to T_L	
-Ramp-up Rate	3°C/second max.
Time maintained above:	
-Temperature (T_L)	217°C
-Time (t_L)	60-150 seconds
Peak Temperature (T_P)	260°C
Time within 5°C of actual Peak Temperature (t_p)	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to Peak Temperature	8 minutes max.